SCLS374L - MAY 1997 - REVISED FEBRUARY 2004

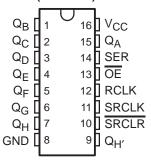
- Inputs Are TTL-Voltage Compatible
- 8-Bit Serial-In, Parallel-Out Shift
- Shift Register Has Direct Clear
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

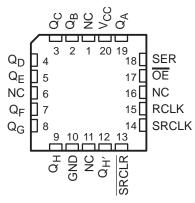
The 'AHCT595 devices contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state outputs. Separate clocks are provided for the shift and storage registers. The shift register has a direct overriding clear (SRCLR) input, serial (SER) input, and serial outputs for cascading. When the output-enable (OE) input is high, the outputs are in the high-impedance state.

Both the shift register clock (SRCLK) and storage register clock (RCLK) are positive-edge triggered. If both clocks are connected together, the shift register always is one clock pulse ahead of the storage register.

SN54AHCT595 . . . J OR W PACKAGE SN74AHCT595 . . . D, DB, N, NS, OR PW PACKAGE (TOP VIEW)



SN54AHCT595 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

| TA | PACK | AGE† | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------|---------------|--------------------------|---------------------|
| | PDIP – N | Tube | SN74AHCT595N | SN74AHCT595N |
| | 0010 D | Tube | SN74AHCT595D | ALIOTEOE |
| –40°C to 85°C | SOIC - D | Tape and reel | SN74AHCT595DR | AHCT595 |
| | SOP - NS | Tape and reel | SN74AHCT595NSR | AHCT595 |
| | SSOP – DB | Tape and reel | SN74AHCT595DBR | HB595 |
| | TOCOD DW | Tube | SN74AHCT595PW | LIDEOE |
| | TSSOP – PW | Tape and reel | SN74AHCT595PWR | HB595 |
| | CDIP – J | Tube | SNJ54AHCT595J | SNJ54AHCT595J |
| -55°C to 125°C | CFP – W | Tube | SNJ54AHCT595W | SNJ54AHCT595W |
| | LCCC - FK | Tube | SNJ54AHCT595FK | SNJ54AHCT595FK |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



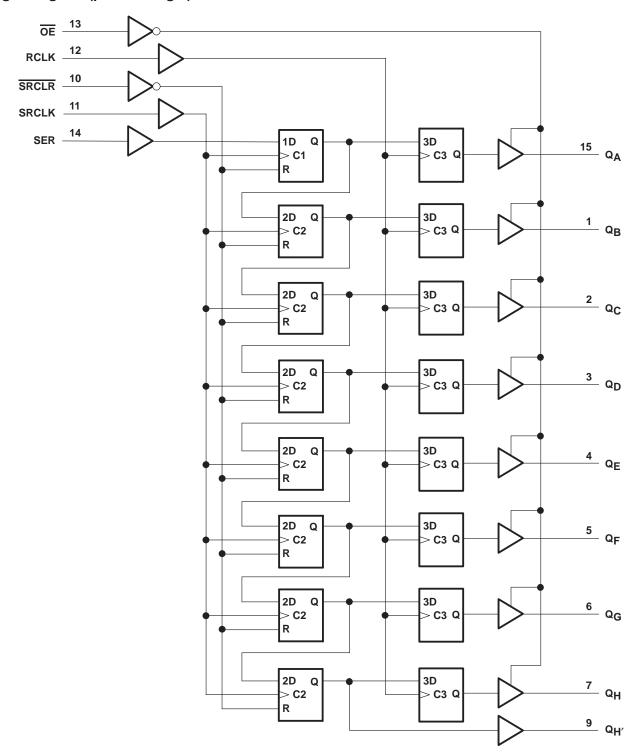
SN54AHCT595, **SN74AHCT595 8-BIT SHIFT RÉGISTERS** WITH 3-STATE OUTPUT REGISTERS SCLS374L - MAY 1997 - REVISED FEBRUARY 2004

FUNCTION TABLE

| | | INPUTS | | | FUNCTION |
|-----|----------|--------|------|----|---|
| SER | SRCLK | SRCLR | RCLK | OE | FUNCTION |
| Х | Х | Х | Х | Н | Outputs Q _A –Q _H are disabled. |
| Х | Χ | Χ | Χ | L | Outputs Q _A –Q _H are enabled. |
| Х | Χ | L | Χ | Χ | Shift register is cleared. |
| L | ↑ | Н | Х | Х | First stage of the shift register goes low. Other stages store the data of previous stage, respectively. |
| Н | 1 | Н | Х | Х | First stage of the shift register goes high. Other stages store the data of previous stage, respectively. |
| Х | Х | Х | 1 | Х | Shift-register data is stored in the storage register. |



logic diagram (positive logic)

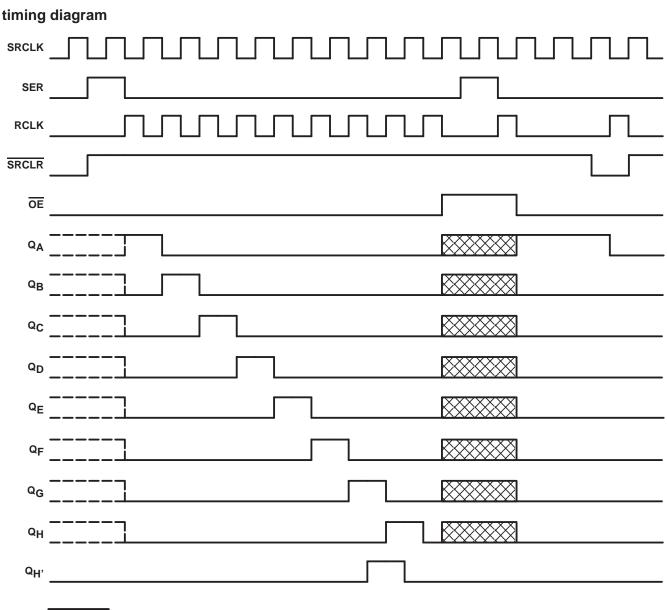


Pin numbers shown are for the D, DB, J, N, NS, PW, and W packages.



SN54AHCT595, SN74AHCT595 8-BIT SHIFT REGISTERS WITH 3-STATE OUTPUT REGISTERS

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NOTE: implies that the output is in 3-State mode.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | | 0.5 V to 7 V |
|--|---------------------------------------|--|
| Input voltage range, V _I (see Note 1) | | 0.5 V to 7 V |
| Output voltage range, VO (see Note 1) | | $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Input clamp current, I_{IK} ($V_I < 0$) | | 20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CO}$ | c) | ±20 mA |
| Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$ | · · · · · · · · · · · · · · · · · · · | ±25 mA |
| Continuous current through V _{CC} or GND | | ±50 mA |
| Package thermal impedance, θ _{JA} (see Note 2): | : D package | 73°C/W |
| - | DB package | 82°C/W |
| | N package | 67°C/W |
| | NS package | 64°C/W |
| | PW package | 108°C/W |
| Storage temperature range, T _{stg} | | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

| | | SN54AH | CT595 | SN74AH | CT595 | |
|----------|------------------------------------|--------|-------|--------|-------|------|
| | | MIN | MAX | MIN | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V_{IH} | High-level input voltage | 2 | 2 | 2 | | V |
| V_{IL} | Low-level input voltage | | 0.8 | | 0.8 | V |
| VI | Input voltage | 0 | 5.5 | 0 | 5.5 | V |
| VO | Output voltage | 0 | VCC | 0 | VCC | V |
| ІОН | High-level output current | 27/ | -8 | | -8 | mA |
| loL | Low-level output current | 70/ | 8 | | 8 | mA |
| Δt/Δν | Input transition rise or fall rate | Q | 20 | | 20 | ns/V |
| TA | Operating free-air temperature | -55 | 125 | -40 | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

SN54AHCT595, SN74AHCT595 8-BIT SHIFT RÉGISTERS WITH 3-STATE OUTPUT REGISTERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | TT0T 001/D/T/01/0 | ., | T, | ղ = 25°C | ; | SN54AH | CT595 | SN74AHCT595 | | |
|-------------------|--|--------------|------|----------|-------|--------|-------|-------------|------|------|
| PARAMETER | TEST CONDITIONS | VCC | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| ., | IOH = -50 μA | 451/ | 4.4 | 4.5 | | 4.4 | | 4.4 | | \/ |
| VOH | I _{OH} = -8 mA | 4.5 V | 3.94 | | | 3.8 | | 3.8 | | V |
| ., | I _{OL} = 50 μA | 4.5.1/ | | | 0.1 | | 0.1 | | 0.1 | ., |
| VOL | I _{OL} = 8 mA | 4.5 V | | | 0.36 | | 0.44 | | 0.44 | V |
| lį | V _I = 5.5 V or GND | 0 V to 5.5 V | | | ±0.1 | | ±1* | | ±1 | μΑ |
| loz | $V_O = V_{CC}$ or GND, $Q_A - Q_H$ | 5.5 V | | | ±0.25 | 4 | ±2.5 | | ±2.5 | μΑ |
| ICC | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V | | | 4 | 20 | 40 | | 40 | μΑ |
| ΔICC [†] | One input at 3.4V, Other inputs at V _{CC} or GND | 5.5 V | | | 2 | PRO | 2.2 | | 2.2 | mA |
| Ci | V _I = V _{CC} or GND | 5 V | | 3 | 10 | | | | 10 | pF |
| Co | VO = VCC or GND | 5 V | | 5.5 | | | | | | pF |

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| | | | T _A = 1 | 25°C | SN54AH | CT595 | SN74AH | CT595 | |
|-----------------|-------------------------------|-------------------------------------|--------------------|------|------------|-------|--------|-------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | SRCLK high or low | 5 | | 5.5 | | 5.5 | | |
| t _w | t _w Pulse duration | RCLK high or low | | | 5.5 | TEL | 5.5 | | ns |
| | | SRCLR low | 5 | | 5 | FE | 5 | | |
| | | SER before SRCLK↑ | 3 | | 3,4 | 2 | 3 | | |
| | 0 | SRCLK↑ before RCLK↑‡ | 5 | | 5 | | 5 | | |
| t _{su} | Setup time | SRCLR low before RCLK↑ | 5 | | S 5 | | 5 | | ns |
| | | SRCLR high (inactive) before SRCLK↑ | 3.4 | | 3.8 | | 3.8 | | |
| th | Hold time | SER after SRCLK↑ | 2 | | 2 | | 2 | | ns |

[‡] This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0 \text{ V}$. † This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or V_{CC} .

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| DADAMETER | FROM | то | LOAD | T, | չ = 25°C | ; | SN54AH | CT595 | SN74AH | | |
|------------------|-------------|--------------------------------|------------------------|------|----------|------|----------------|-------|--------|------|---------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | C _L = 15 pF | 135* | 170* | | 115* | | 115 | | N 41 1- |
| f _{max} | | | C _L = 50 pF | 95 | 140 | | 85 | | 85 | | MHz |
| t _{PLH} | DOLK | 0 . 0 . | C. 15 pF | | 4.3* | 7.4* | 1* | 8.5* | 1 | 8.5 | 20 |
| ^t PHL | RCLK | Q_A – Q_H | C _L = 15 pF | | 4.3* | 7.4* | 1* | 8.5* | 1 | 8.5 | ns |
| ^t PLH | SDCI K | 0 | C. 15 pF | | 4.5* | 8.2* | 1* | 9.4* | 1 | 9.4 | 20 |
| ^t PHL | SRCLK | Q _H ′ | C _L = 15 pF | | 4.5* | 8.2* | 1* | 9.4* | 1 | 9.4 | ns |
| t _{PHL} | SRCLR | $Q_{H'}$ | C _L = 15 pF | | 4.5* | 8* | 1* | 9.1* | 1 | 9.1 | ns |
| ^t PZH | ŌĒ | 0 0 | 0 455 | | 4.3* | 8.6* | 1* | 10* | 1 | 10 | |
| tPZL | OE | Q_A – Q_H | C _L = 15 pF | | 5.4* | 8.6* | 1*, | 10* | 1 | 10 | ns |
| tPLH | BOLK | 0 . 0 | C. 50 pF | | 5.6 | 9.4 | 2 | 10.5 | 1 | 10.5 | 50 |
| ^t PHL | RCLK | Q_A-Q_H | $C_L = 50 pF$ | | 5.6 | 9.4 | Q _C | 10.5 | 1 | 10.5 | ns |
| ^t PLH | SRCLK | 0 | C 50 pF | | 6.4 | 10.2 | 2 1 | 11.4 | 1 | 11.4 | ns |
| ^t PHL | SRULK | Q _H ′ | C _L = 50 pF | | 6.4 | 10.2 | 1 | 11.4 | 1 | 11.4 | 115 |
| ^t PHL | SRCLR | $Q_{H'}$ | C _L = 50 pF | | 6.4 | 10 | 1 | 11.1 | 1 | 11.1 | ns |
| ^t PZH | | | 0 50 5 | | 5.7 | 10.6 | 1 | 12 | 1 | 12 | |
| tPZL | ŌE | Q_A – Q_H | C _L = 50 pF | | 6.8 | 10.6 | 1 | 12 | 1 | 12 | ns |
| ^t PHZ | ŌĒ | 0. 0 | C _L = 50 pF | | 3.5 | 10.3 | 1 | 11 | 1 | 11 | ns |
| t _{PLZ} | OE | Q _A –Q _H | OL = 20 bi- | | 3.4 | 10.3 | 1 | 11 | 1 | 11 | 115 |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

| | DADAMETED | SN7 | | | |
|--------------------|---|-----|------|-----|------|
| | PARAMETER | MIN | TYP | MAX | UNIT |
| VOL(P) | Quiet output, maximum dynamic VOL | | V | | |
| V _{OL(V)} | Quiet output, minimum dynamic V _{OL} | | -0.6 | | V |
| VOH(V) | Quiet output, minimum dynamic VOH | | 3.8 | | V |
| VIH(D) | High-level dynamic input voltage | 2 | | | V |
| V _{IL(D)} | Low-level dynamic input voltage | | | 8.0 | V |

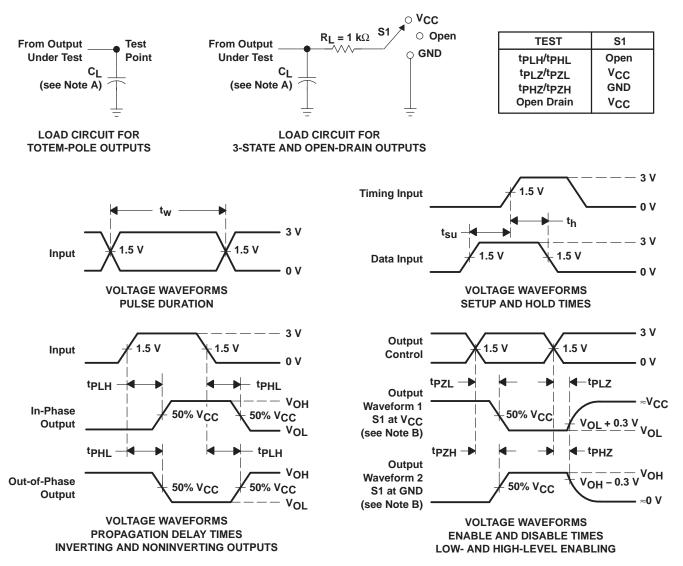
NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| | | PARAMETER | TEST CO | TYP | UNIT | |
|---|-----------------|-------------------------------|----------|-----------|------|----|
| ſ | C _{pd} | Power dissipation capacitance | No load, | f = 1 MHz | 112 | pF |



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \Omega$, $t_f \leq 3$ ns, $t_f \leq 3$ ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







4-Jun-2007

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|------------------------------|
| SN74AHCT595D | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DBR | ACTIVE | SSOP | DB | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DBRE4 | ACTIVE | SSOP | DB | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DBRG4 | ACTIVE | SSOP | DB | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595DRG4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595N | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74AHCT595NE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74AHCT595NSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595NSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595NSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595PW | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595PWE4 | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595PWG4 | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595PWR | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595PWRE4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT595PWRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

(1) The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

4-Jun-2007

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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com 19-Mar-2008

TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

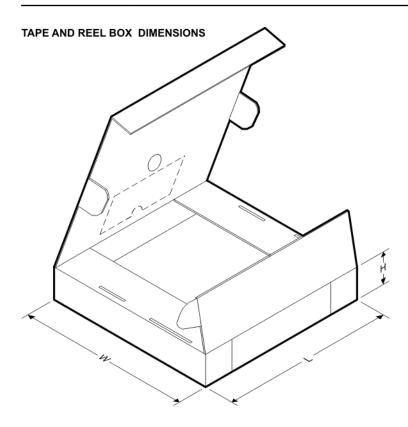
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74AHCT595DBR | SSOP | DB | 16 | 2000 | 330.0 | 16.4 | 8.2 | 6.6 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74AHCT595DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74AHCT595NSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74AHCT595PWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 7.0 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |





*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHCT595DBR | SSOP | DB | 16 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74AHCT595DR | SOIC | D | 16 | 2500 | 333.2 | 345.9 | 28.6 |
| SN74AHCT595NSR | SO | NS | 16 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74AHCT595PWR | TSSOP | PW | 16 | 2000 | 346.0 | 346.0 | 29.0 |

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

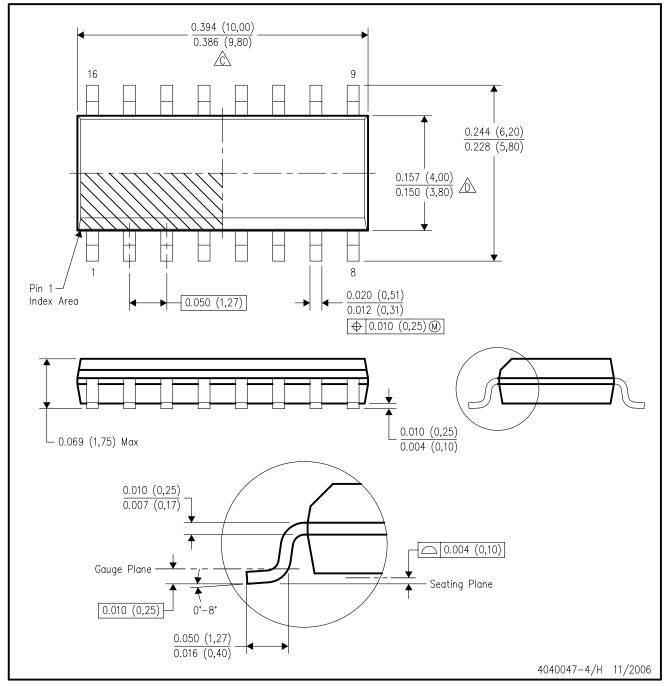
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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